#### 501847631 03/09/2012

# PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

# **CONVEYING PARTY DATA**

Name	Execution Date
Tatsuya FUKUGAKI	02/08/2012
Masaaki HANAWA	02/08/2012
Hiroshi OHGA	02/08/2012

# **RECEIVING PARTY DATA**

Name:	HITACHI HIGH-TECHNOLOGIES CORPORATION	
Street Address:	24-14, Nishi Shimbashi 1-chome, Minato-ku	
City:	Tokyo	
State/Country:	JAPAN	

# PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13389942

# **CORRESPONDENCE DATA**

Fax Number: (703)684-1157 Phone: 7036841120

Email: jange@mmiplaw.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

via US Mail.

Correspondent Name: Mattingly & Malur, PC Address Line 1: 1800 Diagonal Road

Address Line 2: Suite 370

Address Line 4: Alexandria, VIRGINIA 22314

ATTORNEY DOCKET NUMBER: KAS-8238

NAME OF SUBMITTER: Shrinath Malur

Total Attachments: 1

501847631

source=8238Assignment#page1.tif

PATENT

REEL: 027834 FRAME: 0941

# **ASSIGNMENT**

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI HIGH-TECHNOLOGIES CORPORATION, a corporation organized under the laws of Japan,

located at 24-14, Nishi Shimbashi 1-chome, Minato-ku, Tokyo 105-8717 Japan receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI HIGH-TECHNOLOGIES CORPORATION,

its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

# AUTOMATED SAMPLE TESTING SYSTEM

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said HITACHI HIGH-TECHNOLOGIES CORPORATION,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference preceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI HIGH-TECHNOLOGIES CORPORATION,

Signed on the date(s) indicated aside our signatures:

RECORDED: 03/09/2012

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1) Tatsuya Fukugak!	2/8/2012
1) Tatsuya Fukugak!. Tatsuya FUKUGAKI 2) Masaaki Hanawa	2/8/20/2
Masaaki HANAWA  Hiroshi Ohga	2/8/2012
Hiroshi OHGA	
5)	
6)	-
7)	
8)	
9)	
10)	

PATENT REEL: 027834 FRAME: 0942